

#### 立威科技股份有限公司 Attend Technology Inc.

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## SPECIFICATION AND PERFORMANCE

Series	115Q-BCA0	File	115Q-BCA0_SPEC_3	Date	2024/05/06
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# Scope:

This specification covers the requirements for product performance, test methods and quality assurance provisions of **115Q-BCA0** 

## **Performance and Descriptions:**

The product is designed to meet the electrical, mechanical and environmental performance requirements specification. Unless otherwise specified, all tests are performed at ambient environmental conditions.

## **RoHS:**

All material in according with the RoHS environment related substances list controlled.

	MATERIALS			
NO.	PART NAME	DESCRIPTION		
1	HOUSING	LCP E130i, UL94V-0, Black		
2	CONTACT	C5210R-H, 0.12t, 5u" min. gold on contact area, 1u" min. gold on tail area, under plated: 50u" min. nickel		
3	SPRING	SWP-B, 0.20d, 65u" min. nickel Plating over all		
4	CRANK	SUS304 or SUS130M, 0.35d		
5	SHELL	SUS304CSP-3/4H, 0.15t, 50u" min. nickel plated		
6	SLIDER	LCP E130i, UL94V-0, Black		

RATING		
Rated Voltage	10V DC/AC	
Rated Current	0.5A DC/AC	
Operating Temperature	-40~+85°C	
Storage Temperature	-40~+85°C	
Durability	5000 CYCLES	

ELECTRICAL			
Item	Requirement	Test Condition	
Contact Resistance (Low level)	Contact terminals: $100\text{m}\Omega$ max. Switch terminals: $140\text{m}\Omega$ max.	Subject mated contacts assembled in housing to 20mV max., Open circuit at 10mA. Refer to Figure 1	
Insulation Resistance	1000M $\Omega$ min. initial 100M $\Omega$ min. after test	Impressed voltage 500V DC for 1 minute. Test between adjacent circuit EIA364-21	
Dielectric Withstanding	No creeping discharge nor	500V AC for 1 minute. Test between adjacent	

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Voltage	flash over shall occur. Current leakage: 1mA	circuit. EIA364-20
	max.	
Temperature Rise	30°C max. under loaded rating current	The contacts shall be wired in series and apply rated current. Measure the temperature rising on contact.

MECHANICAL			
Item	Requirement	Test Condition	
Durability	Max. change from initial contact resistance $40m\Omega$ max. no physical damage to connector shall occur	Cycle rate: 400 to 600 cycles per hour No. of cycle: 5,000 cycles. EIA 364-09	
Insertion Force	1.0kgf (10N)Max	Measure the module card insertion force at 25± 3mm/min. EIA364-13	
Withdrawal Force	0.05kgf (0.5N) Min.	Measure the mated module card extraction force from the socket at 25±3mm/min. EIA364-13	
Mechanical Shock	Max. Change from initial contact Resistance 40 m $\Omega$ Max no electrical discontinuity greater than 100nsec. shall occur	Accelerated Velocity: 50 G (490 m/sec^2) Waveform: Semi Sine Duration: 11 m sec. No of Shocks: 6/dir., 3 axis,( total of 18 Shocks), EIA364-27	
Vibration	Max. Change from initial contact Resistance 40 m $\Omega$ Max no electrical discontinuity greater than 100nsec. shall occur	Frequency Range: 10-55-10 Total Amplitude: 1.52 mm p-p or 9.81m/sec^2. Duration: 2 hours tree axes( 6 hours in total ) EIA364-28	

ENVIRONMENTAL			
Item	Requirement	Test Condition	
Humidity-Thermal Cycling	Max. Change from initial contact Resistance 40 m $\Omega$ Max Insulation Resistance: 1000 M $\Omega$ Min. initial 100 M $\Omega$ Min. after test No physical damage to connector shall occur.	Ambient Temp.: 25 to 60°C Relative humidity: 90 to 95 % Duration: 10 cycles EIA364-31	
Thermal Shock	Max. Change from initial contact Resistance 40 mΩ Max No physical damage to connector shall occur.	Temperature Range: -55 to 85°C No. of Cycles: 5 cycles for 30 minutes EIA364-32	
Temperature Life	Max. Change from initial	Chamber Temperature: 85±2°C	



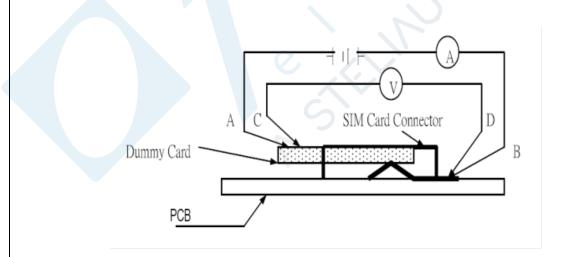
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	contact Resistance 40 m $\Omega$ Max No physical damage to connector shall occur.	Duration: 250 hours EIA364-17
Low Temperature Resistance	Max. Change from initial contact Resistance 40 m $\Omega$ Max No physical damage to connector shall occur.	Chamber Temperature: - 40±2°C  Duration: 96 hours  Dummy card engaged during test EIA364-59
Salt Spray Test	Max. Change from initial contact Resistance 40 mΩ Max No physical damage to connector shall occur.	Salt Solution: 5±1.0% Length of Test: 48 hours Dummy card engaged during test EIA364-26

SOLDER ABILITY				
Item	Requirement	Test Condition		
Solder ability	Wet Solder Coverage: 95% Min.	Solder Temperature: 245±3°C Immersion Duration: 3 ±0.5 sec. Solder: Sn-3Ag-0.5Cu Flux: RMA 25%		
Solder-Heat Resistance Solder-Heat Resistance Solder-Heat Resistance Solder-Heat Resistance Solder-Heat Resistance fusion of housing and no physical damage after test.		Refer to Reflow Profile		

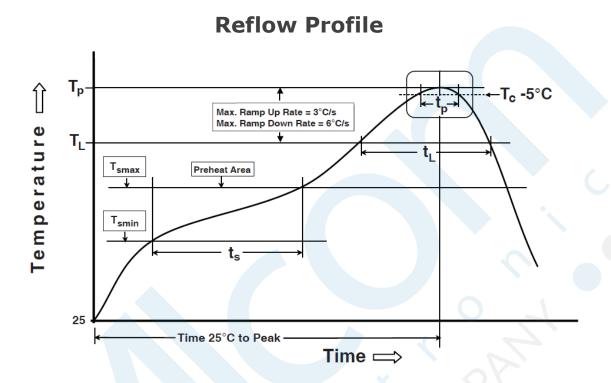
### FIGURE I: CONTACT RESISTANCE







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Preheating temperature:  $150 \sim 200$ °C,  $60 \sim 120$  seconds Liquidus temperature (TL): 217°C,  $60 \sim 150$  seconds

Peak temperature: 260°C

Time within 5 °C of peak temperature (Tc): 255°C, 30seconds

